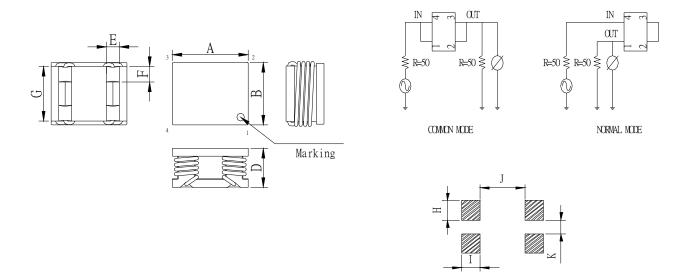
SH TYPE

FEATURE

- Dual-winding configuration makes 1 unit suffice for one port
- 2. An excellent TPA/TPB impedance balance is ensured due to winding on a single core

Applications

- DC-DC converter of portable equipment
- 2. Notebook, LCD TV and others
- Shape and Dimension and Schematics and Land Patterns(mm)



Specification Dimension in m/m

TYPE	Α	В	D	Е	F	G	Н	I	J	K
SH 8x6x3-4.5Ts	7.50±0.20	6.00±0.20	3.00±0.20	1.50	1.50	5.40	1.90	2.40	2.00	1.50
SH 10x8x5-4.5Ts	10.0±0.20	8.00±0.20	5.00±0.20	1.80	1.50	7.00	2.40	2.10	4.20	2.60

Note1. Measurement ambient temperature of Impedance, DCR and IDC : at 25° C

Note2. Test equipment: HP4291A

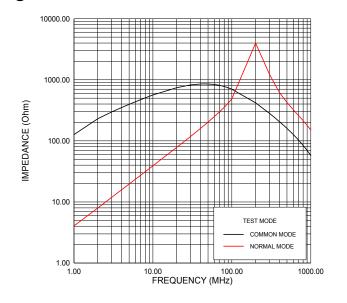
Note3. This specification might be changed without notice due to under developing and improving.

Thank you for your understanding.

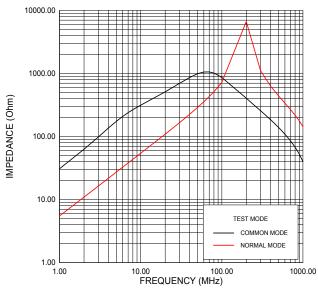
FENG-JUI TECHNOLOGY CO., LTD EMI SOLOTION PRODUCTS-RoHS

Electrical	Fraguency	Electrical Characteristics					
Characteristics	Frequency	SH 8x6x3-4.5Ts	SH 10x8x5-4.5Ts				
Common mode	100MHz	$700~\Omega \pm 25\%$	$860~\Omega \pm 25\%$				
	400MHz	$200~\Omega \pm 25\%$	180 $\Omega \pm 25\%$				
Normal mode	100MHz	$600~\Omega \pm 25\%$	$720~\Omega \pm 25\%$				
	400MHz	$100~\Omega \pm 25\%$	$620~\Omega \pm 25\%$				
DC Resistance		50mΩMax	45mΩMax				
Rated current		5A	5A				

●SH 8x6x3-4.5Ts



●SH 10x8x5-4.5Ts



GENERAL CHARACTERISTICS

- 1. Operating temperature range: -25 TO + 105°C (Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- 3. Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Y withstanding at below conditions.

Terminal should not peel off. (refer to figure at right) 5. 0N 60 sec.

- 4. Insulating resistance: Over $100M\Omega$ at 100V D.C. between coil and core.
- 5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- 6. Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C (-25~+80°C).
- 7. Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2°C and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260°C, 10 seconds(See attached recommend reflow)
- 11. Storage environment: Storage condition: Temperature Range: $10^{\circ}\text{C} \sim 35^{\circ}\text{C}$ (Generally: $21^{\circ}\text{C} \sim 31^{\circ}\text{C}$) , Humidity Range: $50\% \sim 80\%$ RH (Generally: $65\% \sim 75\%$); Transportation condition: Temperature Range: $-35^{\circ}\text{C} \sim 85^{\circ}\text{C}$, Humidity Range: $50\% \sim 95\%$ RH
- 12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
- 13. Reflow profile recommend:

Lead-free heat endurance test

Lead-free the recommended reflow condition

